

## DUAL USB HIGH-SIDE POWER SWITCH

The AP1212 series are dual integrated high-side power switch

with independent enable and flag functions, optimized for

self-powered and bus-powered Universal Serial Bus (USB)

applications. The AP1212 series support the following USB

on-resistance meets USB voltage drop requirements; fault

current is limited to typically 1000mA, well below the UL 25VA

conditions to the local USB controller. Soft start eliminates the

momentary voltage drop on the upstream port that may occur

when the switch is enabled in bus-powered applications.

Additional features include thermal shutdown to prevent

safety requirements; and a flag output is available to indicate fault

catastrophic switch failure from high-current loads, under voltage

lockout (UVLO) to ensure that the device remains off unless there

is a valid input voltage present, and 3.3V and 5V logic compatible

required by USB downstream devices; the switch's low

requirements: each switch channel supplies up to 500mA as

**General Description** 

enable inputs.

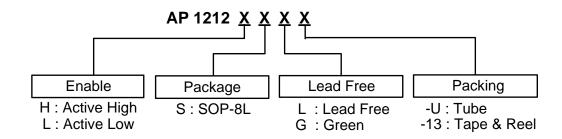
### Features

- Compliant to USB specifications
- Dual independent switches control
- 2.7V to 5.5V input voltage
- 500mA minimum continuous current per port
- 110mΩ typical on-resistance
- 1.25A maximum short circuit current limit
- Independent open-drain fault flag pins
- 110µA typical on-state supply current
- 1µA typical off-state supply current
- Output can be forced higher than input (off-state)
- Thermal shutdown
- 2.4V typical under voltage lockout (UVLO)
- 1ms turn-on (soft-start) and fast turn-off
- Enable active-high (H) or active-low (L)
- SOP-8L: Available in "Green" Molding Compound (No Br, Sb)
- Lead Free Finish/RoHS Compliant (Note 1)

## **Applications**

- USB hubs
- Hot plug-in power supplies
- Battery-charger circuits

## **Ordering Information**



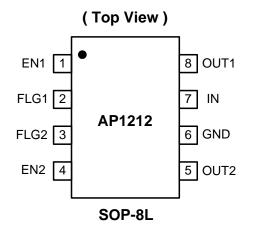
ſ		Backago	Backaging	Tube		13" Tape and Reel		
	Device	Code	Packaging (Note 2)	Quantity	Part Number Suffix	Quantity	Part Number Suffix	
<b>Pb</b> ,	AP1212XS	S	SOP-8L	100	-U	2500/Tape & Reel	-13	

Notes: 1. RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see *EU Directive Annex Notes 5 and 7*. 2. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be on found our website at <u>http://www.diodes.com/datasheets/ap02001.pdf</u>.



## DUAL USB HIGH-SIDE POWER SWITCH

# **Pin Assignments**



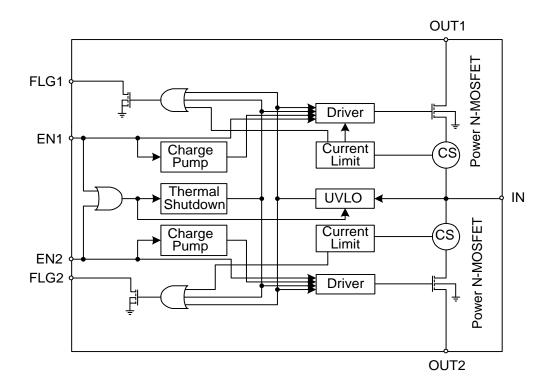
## **Pin Descriptions**

Pin Name	Description		
EN1 EN2	Enable: Logic-compatible enable input. (H: active high, L: active low). Do not float.		
FLG1 FLG2Fault Flag: Active-low, open-drain output. Indicates over current, UVLO, and shutdown.			
GND	Supply return.		
IN	Supply Input: Output MOSFET drain. Also supplies IC's internal circuitry. Connect to positive supply.		
OUT1 OUT2	Switch Output: Output MOSFET source. Typically connect to switched side of load.		

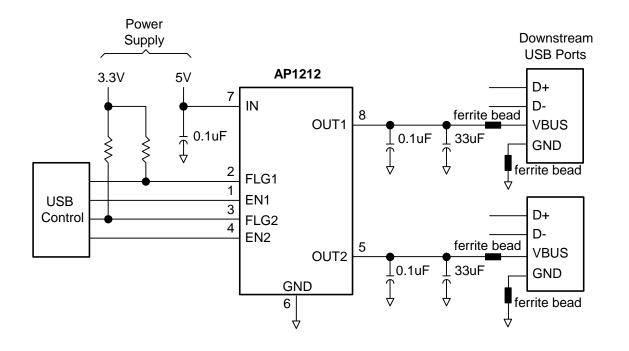


## **DUAL USB HIGH-SIDE POWER SWITCH**

## **Block Diagram**



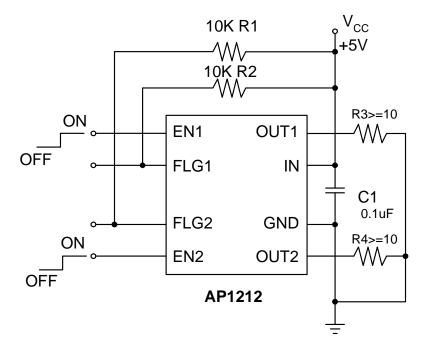
## **Typical Application Circuit**





## **DUAL USB HIGH-SIDE POWER SWITCH**

#### **Test Circuit** (Note 3)



Notes: 3. Before EN is asserted, a delay of 10ms minimum from when the supply voltage, Vcc, becomes stable must be allowed.

#### **Absolute Maximum Ratings** (Note 4)

Symbol	Parameter	Rating	Unit
ESD HBM	Human Body Model ESD Protection (Note 5)	500	V
ESD MM	Machine Model ESD Protection (Note 5)	150	V
V <sub>IN</sub>	Supply Voltage	+7	V
V <sub>FLG</sub>	Fault Flag Voltage	+7	V
I <sub>FLG</sub>	Fault Flag Current	50	mA
V <sub>OUT</sub>	Output Voltage	+7	V
V <sub>EN</sub>	Control Input Range	–0.3 to V <sub>IN</sub> +2	V
T <sub>ST</sub>	Storage Temperature	-65 to +150	°C

#### **Recommended Operating Conditions** (Note 6)

Symbol	Parameter	Min	Max	Unit
V <sub>IN</sub>	Supply Voltage	2.7	5.5	V
T <sub>A</sub>	Operating Ambient Temperature	-40	125	О°

Notes: 4. Exceeding the absolute maximum rating may damage the device.

5. Devices are ESD sensitive. Handling precautions are recommended. Human Body model, tested per JEDEC 22-A114. Machine model, tested per JEDEC 22-A115. 6. The device is not guaranteed to function outside its operating rating.



## DUAL USB HIGH-SIDE POWER SWITCH

## **Electrical Characteristics**

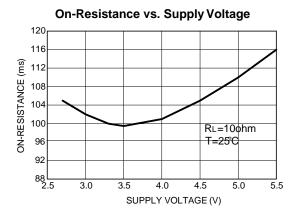
Symbol Parameter		Conditions	Min	Тур.	Max	Unit
		Switch off, OUT = open (Note 7)		0.50	5	μA
I <sub>CC</sub>	Supply Current	All switches on, OUT = open (Note 7)		110	160	μA
VIT	Enable Input Threshold	(Note 7)	0.8	1.7	2.40	V
I <sub>EN</sub>	Enable Input Current	$V_{EN} = 0V$ to 5.5V	-1	±0.01	1	μA
$C_{EN}$	Enable Input Capacitance			1		pF
R <sub>DS(ON)</sub>	Switch Resistance	$V_{IN} = 2.7V \sim 5.5V, I_{OUT} = 500mA$ , each switch		110	140	mΩ
T <sub>OND</sub>	Output Turn-On Delay	$R_L = 10\Omega$ each output		30		μS
T <sub>R</sub>	Output Turn-On Rise Time	$R_{L} = 10\Omega$ each output		1		mS
T <sub>OFFD</sub>	Output Turnoff Delay	$R_L = 10\Omega$ each output		0.5	10	μS
T <sub>F</sub>	Output Turnoff Fall Time	$R_{L} = 10\Omega$ each output		0.5	10	μS
I <sub>LEAK</sub>	Output Leakage Current	Each output (output disabled)			10	μA
I <sub>OUT</sub>	Continuous Load Current	Each output	0.6			A
I <sub>OS</sub>	Short-circuit Current Limit	Each output (enable into load), $V_{OUT} = 0V$	0.8	1.0	1.25	А
I <sub>LIM</sub>	Current-Limit Threshold Ramped load applied to enabled output		1.0	1.2	1.4	А
-	Over-temperature	T <sub>J</sub> increasing		140		°C
$T_{TS}$	Shutdown Threshold	T <sub>J</sub> decreasing		130		°C
P	Error Flag Output	$V_{IN} = 5V, I_L = 10mA$		10	25	Ω
$R_{FO}$	Resistance	$V_{IN} = 3.3V, I_L = 10mA$		15	40	Ω
I <sub>FOH</sub>	Error Flag Off Current	$V_{FLAG} = 5V$		0.01	1	μA
		V <sub>IN</sub> = increasing		2.5		V
UVLO	UVLO Threshold	V <sub>IN</sub> = decreasing		2.3		V
$\theta_{JA}$	Thermal Resistance Junction-to-Ambient	SOP-8L		165		°C/W
$\theta_{\text{JC}}$	Thermal Resistance Junction-to-Case	SOP-8L		26		°C/W

Notes: 7. Off is  $V_{EN} \leq 0.8V$  and on is  $V_{EN} \geq 2.4V$  for the AP1212H. Off is  $V_{EN} \geq 2.4V$  and on is  $V_{EN} \leq 0.8V$  for the AP1212L.

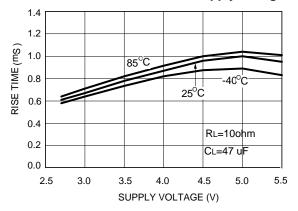


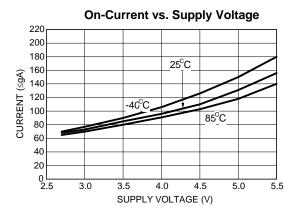
## **DUAL USB HIGH-SIDE POWER SWITCH**

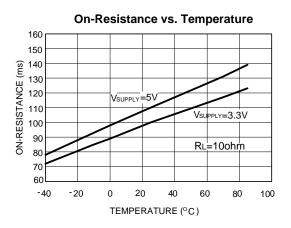
## **Typical Performance Characteristics**



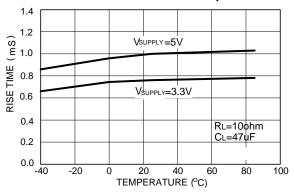




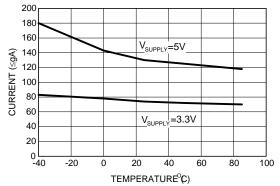




Turn-On Rise Time vs. Temperature



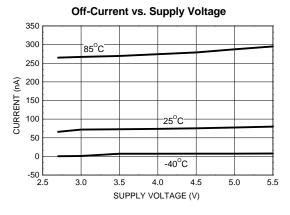
**On-Current vs. Temperature** 

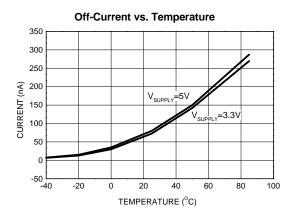




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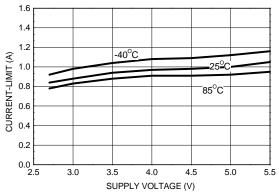
# Typical Performance Characteristics (Continued)



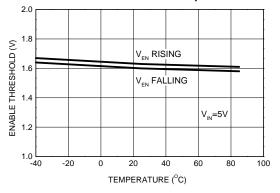


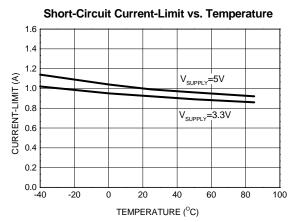
Enable Threshold vs. Supply Voltage 2.0 1.8 ENABLE THRESHOLD (V) 1.6 V<sub>EN</sub> RISIN 1.4 V<sub>EN</sub> FÄLLING 1.2 T=25°C 1.0 L 2.5 3.0 3.5 4.0 4.5 5.0 5.5 SUPPLY VOLTAGE (V)

Short-Circuit Current-Limit vs. Supply Voltage



Enable Threshold vs. Temperature



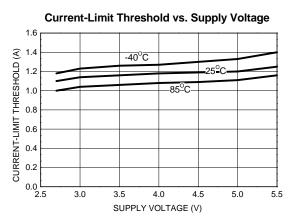


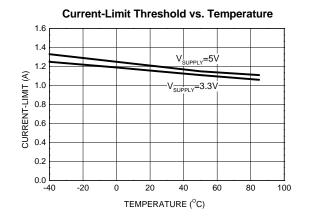
AP1212 Rev. 4



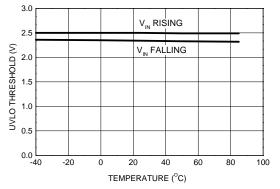
# DUAL USB HIGH-SIDE POWER SWITCH

## Typical Performance Characteristics (Continued)





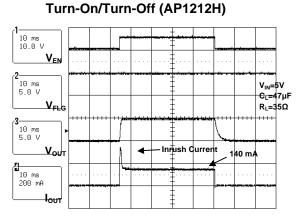
UVLO Threshold vs. Temperature





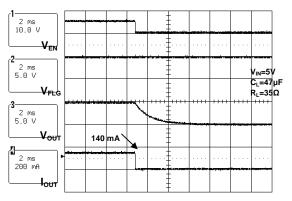
## **DUAL USB HIGH-SIDE POWER SWITCH**

#### **Typical Performance Characteristics** (Continued)

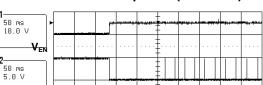


### TIME (10mS/div.)

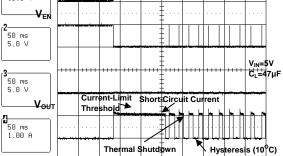
### Turn-Off (AP1212H)



TIME (2mS/div.)

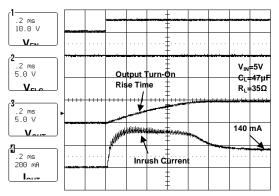


# Current-Limit Response (AP1212H)



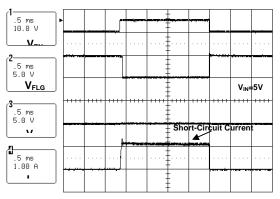
TIME (50mS/div.)

## Turn-On (AP1212H)



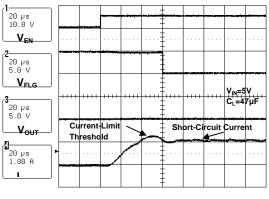
### TIME (200µS/div.)

### Enabled Into Short (AP1212H)



### TIME (500µS/div.)

### Current-Limit Response (AP1212H)



TIME (20µS/div.)

## **DUAL USB HIGH-SIDE POWER SWITCH**

# **Functional Description**

O R

Δ

R P

### Error Flag

O

An open-drained output of N-channel MOSFET, the FLG output is pulled low to signal the following fault conditions: input under voltage, output current limit, and thermal shutdown.

#### **Current Limit**

The current limit threshold is preset internally. It protects the output MOSFET switches from damage due to undesirable short circuit conditions or excess inrush current often encountered during hot plug-in. The low limit of the current limit threshold of the AP1212 allows a minimum current of 0.5A through the MOSFET switches. A current limit condition will signal the error flag.

#### Thermal Shutdown

When the chip temperature exceeds 140°C for any reason other than over current fault of either one of the two MOSFET switches, the thermal shutdown function turns off both MOSFET switches and signals the error flag. A hysteresis of 10°C prevents the MOSFETs from turning back on until the chip temperature drops to below 130°C.

#### Enable

Before EN is asserted, a delay of 10ms minimum from when the supply voltage, Vcc, becomes stable must be allowed.

#### Supply Filtering

A  $0.1\mu$ F to  $1\mu$ F bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

#### **Transient Droop Requirements**

USB applications support dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.

### Short Circuit Transient

Bulk capacitance provides the short-term transient current needed during a hot-attachment event. With a  $33\mu$ F, 16V tantalum or  $100\mu$ F, 10V electrolytic capacitor mounted close to downstream connector per port should provide transient drop protection.

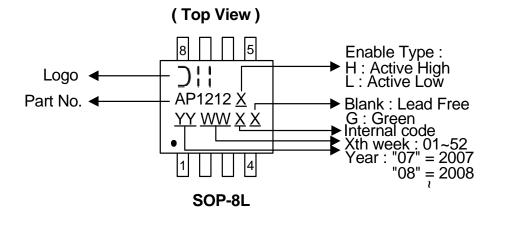
### **Printed Circuit Layout**

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.



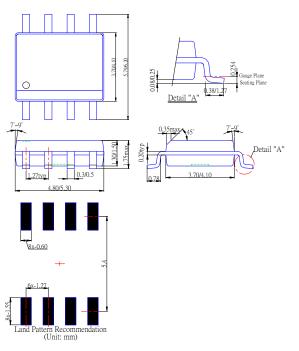
## **DUAL USB HIGH-SIDE POWER SWITCH**

## **Marking Information**



Package Information (All Dimensions in mm)

Package Type: SOP-8L





## **DUAL USB HIGH-SIDE POWER SWITCH**

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